TOSHIBA

2017-10-30 Rev.1.0

RD Number: RD094

RD Title: TC78S121FTG Evaluation circuit

Item No.	Designator	Quantity	Value	Part Number	Manufacturer	Description	Package	Not Mount
1	C_OSCM	1	270pF	GRM31A7U3A271JW31D	murata	Chip capacitor		
2	C_VCC	1	0.1uF	GRM319R72A104KA01D	murata	Chip capacitor		
3	C_VDD	1	10uF	EKMG500ELL100ME11D	NIPPON CHEMI-CON	Electrolytic capacitor		
4	C_VM1	1	100uF	EKMG500ELL101MHB5D	NIPPON CHEMI-CON	Electrolytic capacitor		
5	R_MO_AB	0	100kΩ	RK73B2BTTD104J	KOA	Chip resistor		✓
6	R_MO_CD	0	100kΩ	RK73B2BTTD104J	KOA	Chip resistor		✓
7	R_ALERT	1	10kΩ	RK73B2BTTD103J	KOA	Chip resistor		
8	R_OSCM	1	120kΩ	RK73B2BTTD124J	KOA	Chip resistor		
9	R_VRFA	0		GF063U	tocos			✓
10	R_VRFB	0		GF063U	tocos			✓
11	R_VRFC	0		GF063U	tocos			✓
12	R_VRFD	0		GF063U	tocos			✓
13	R_RSA	1	0.22Ω	ERJ-12ZQJR22U	Panasonic	Chip resistor		
14	R_RSB	1	0.22Ω	ERJ-12ZQJR22U	Panasonic	Chip resistor		
15	R_RSC	1	0.22Ω	ERJ-12ZQJR22U	Panasonic	Chip resistor		
16	R_RSD	1	0.22Ω	ERJ-12ZQJR22U	Panasonic	Chip resistor		
17	C_VM2	1	0.1uF	GRM319R72A104KA01D	murata	Chip capacitor		
18	C_VRFA	1	0.1uF	GRM319R72A104KA01D	murata	Chip capacitor		
19	C_VRFB	1	0.1uF	GRM319R72A104KA01D	murata	Chip capacitor		
20	C_VRFC	1	0.1uF	GRM319R72A104KA01D	murata	Chip capacitor		
21	C_VRFD	1	0.1uF	GRM319R72A104KA01D	murata	Chip capacitor		
22	IN_C1	1		ST-1-3	MAC8			
23	IN_D2	1		ST-1-3	MAC8			
24	IN_D1	1		ST-1-3	MAC8			
25	VDD	1		ST-1-3	MAC8			
26	GND	10		ST-1-3	MAC8			

27	VREF_A	1		ST-1-3	MAC8			
28	VREF_B	1		ST-1-3	MAC8			
29	VREF_C	1		ST-1-3	MAC8			
30	VREF_D	1		ST-1-3	MAC8			
31	OSCM	1		ST-1-3	MAC8			
32	VCC	1		ST-1-3	MAC8			
33	SLEEP	1		ST-1-3	MAC8			
34	ALERT	1		ST-1-3	MAC8			
35	PHASE_A	1		ST-1-3	MAC8			
36	PHASE_B	1		ST-1-3	MAC8			
37	PHASE_C	1		ST-1-3	MAC8			
38	PHASE_D	1		ST-1-3	MAC8			
39	D_TBLANK_AB	1		ST-1-3	MAC8			
40	D_TBLANK_CD	1		ST-1-3	MAC8			
41	MODE2	1		ST-1-3	MAC8			
42	MODE1	1		ST-1-3	MAC8			
43	MODE0	1		ST-1-3	MAC8			
44	IN_A2	1		ST-1-3	MAC8			
45	IN_C2	1		ST-1-3	MAC8			
46	VM	1		ST-1-3	MAC8			
47	IN_A1	1		ST-1-3	MAC8			
48	IN_B2	1		ST-1-3	MAC8			
49	IN_B1	1		ST-1-3	MAC8			
50	SW1	1		2130S1*3GSE	linkman	Jumper		
51		1		2180BBA	linkman	Jumper Short		
52	SW2	1		2130S1*3GSE	linkman	Jumper		
53		1		2180BBA	linkman	Jumper Short		
54	SW3	1		2130S1*3GSE	linkman	Jumper		
55		1		2180BBA	linkman	Jumper Short		
56	SW4	1		2130S1*3GSE	linkman	Jumper		
57		1		2180BBA	linkman	Jumper Short		
58	SW5	0		2130S1*3GSE	linkman	Jumper		✓
59		0		2180BBA	linkman	Jumper Short		✓
60	SW6	0		2130S1*3GSE	linkman	Jumper		✓

61		0		2180BBA	linkman	Jumper Short		✓
62	SW7	0		2130S1*3GSE	linkman	Jumper		✓
63		0		2180BBA	linkman	Jumper Short		✓
64	SW8	0		2130S1*3GSE	linkman	Jumper		✓
65		0		2180BBA	linkman	Jumper Short		✓
66	SW9	1		2130S1*3GSE	linkman	Jumper		
67		1		2180BBA	linkman	Jumper Short		
68	SW10	1		2130S1*3GSE	linkman	Jumper		
69		1		2180BBA	linkman	Jumper Short		
70	SW11	1		2130S1*3GSE	linkman	Jumper		
71		1		2180BBA	linkman	Jumper Short		
72	SW12	1		2130S1*3GSE	linkman	Jumper		
73		1		2180BBA	linkman	Jumper Short		
74	SW13	1		2130S1*3GSE	linkman	Jumper		
75		1		2180BBA	linkman	Jumper Short		
76	SW14	1		2130S1*3GSE	linkman	Jumper		
77		1		2180BBA	linkman	Jumper Short		
78	SW15	1		2130S1*3GSE	linkman	Jumper		
79		1		2180BBA	linkman	Jumper Short		
80	SW16	1		2130S1*3GSE	linkman	Jumper		
81		1		2180BBA	linkman	Jumper Short		
82	SW17	1		2130S1*3GSE	linkman	Jumper		
83		1		2180BBA	linkman	Jumper Short		
84	SW18	1		2130S1*3GSE	linkman	Jumper		
85		1		2180BBA	linkman	Jumper Short		
86	JP1	1		2130S1*2GSE	Linkman	Jumper		
87		1		2180BBA	Linkman	Jumper Short		
88	CON1	1		DF1BZ-4P-2.5DSA	Hirose Electric	Socket		
89	CON2	1		DF1BZ-4P-2.5DSA	Hirose Electric	Socket		
90	IC1	1		TC78S121FTG	toshiba			
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